

PHOTOCOUPLER PS8101

1 Mbps HIGH CMR ANALOG OUTPUT TYPE 5-PIN SOP (SO-5) PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS8101 is an optically coupled isolator containing a GaAlAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

This is a plastic SOP (Small Out-line Package) type for high density applications.

FEATURES

- High common mode transient immunity (CMH, CML = $\pm 10 \text{ kV}/\mu \text{s MIN.}$)
- Small package (SO-5)
- High supply voltage (Vcc = 35 V)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- High-speed response (tphL = 0.8 μ s MAX., tpLH = 1.2 μ s MAX.)
- Ordering number of taping product: PS8101-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008902 (Option)

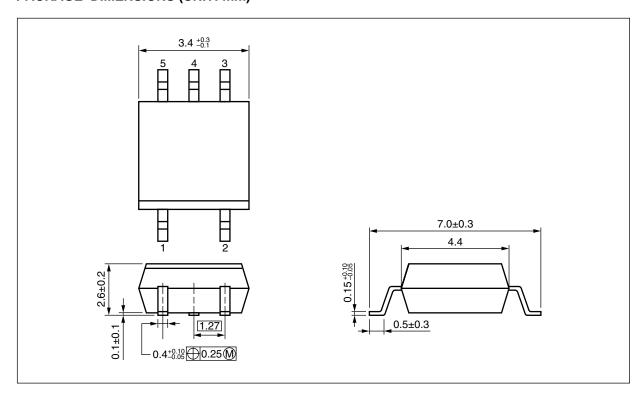
PIN CONNECTION (Top View) 5 4 3 1. Anode 2. Cathode 3. GND 4. Vo 5. Vcc

APPLICATIONS

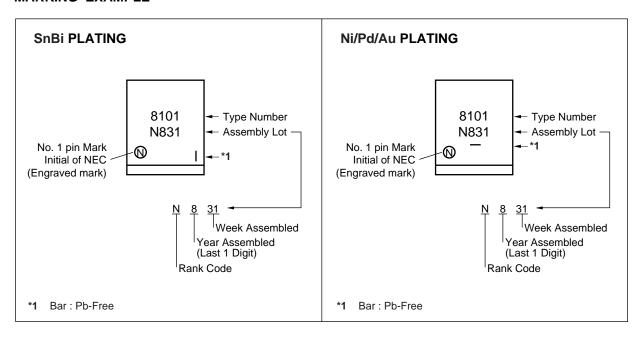
- · Computer and peripheral manufactures
- · General purpose inverter
- Substitutions for relays and pulse transformers
- Power supply

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style Safety Standard Approval		Application Part Number*1
PS8101	PS8101-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS8101
PS8101-F3	PS8101-F3-A	(SnBi)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS8101-F4	PS8101-F4-A				
PS8101-V	PS8101-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS8101-V-F3	PS8101-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS8101-V-F4	PS8101-V-F4-A			Approved (Option)	
PS8101	PS8101-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	
PS8101-F3	PS8101-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS8101-F4	PS8101-F4-AX				
PS8101-V	PS8101-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS8101-V-F3	PS8101-V-F3-AX		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS8101-V-F4	PS8101-V-F4-AX			Approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	lF	25	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation*1	Po	45	mW
Detector	Supply Voltage	Vcc	35	V
	Output Voltage	Vo	35	V
	Output Current	lo	8.0	mA
	Power Dissipation*2	Pc	100	mW
Isolation Voltage*3		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100	°C
Storage Temperature		T _{stg}	-55 to +125	°C

^{*1} Reduced to 0.45 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

^{*2} Reduced to 1.00 mW/°C at $T_A = 25$ °C or more.

^{*3} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

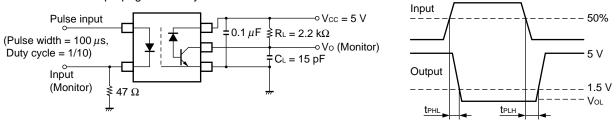
ELECTRICAL CHARACTERISTICS (TA = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 16 mA		1.7	2.2	V
	Reverse Current	I R	VR = 3 V			10	μA
	Forward Voltage Temperature Coefficient	ΔVF/ΔTA	I _F = 16 mA		-2.1		mV/°C
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	High Level Output Current	Іон (1)	IF = 0 mA, Vcc = Vo = 5.5 V		3	500	nA
	High Level Output Current	Іон (2)	IF = 0 mA, Vcc = Vo = 30 V			100	μA
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, Io = 1.2 mA		0.1	0.4	٧
	Low Level Supply Current	Iccl	IF = 16 mA, Vo = open, Vcc = 30 V		50		μA
	High Level Supply Current	Іссн	IF = 0 mA, Vo = open, Vcc = 30 V		0.01	2	
Coupled	Current Transfer Ratio*1	CTR	IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V	15	20	35	%
	Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Propagation Delay Time $(H \rightarrow L)^{*2}$	t PHL	IF = 16 mA, Vcc = 5 V, RL = 2.2 k Ω , CL = 15 pF		0.5	0.8	μs
	Propagation Delay Time $(L \rightarrow H)^{*2}$	tрLH			0.6	1.2	
	Common Mode Transient Immunity at High Level Output ¹³	Смн	IF = 0 mA, Vcc = 5 V, RL = 4.1 k Ω , Vcm = 1.5 kV	10			kV/μs
	Common Mode Transient Immunity at Low Level Output ^{*3}	Смь	$I_F = 16 \text{ mA}, \text{ Vcc} = 5 \text{ V}, \text{ RL} = 4.1 \text{ k}\Omega, \\ \text{VcM} = 1.5 \text{ kV}$	-10			

*1 CTR rank

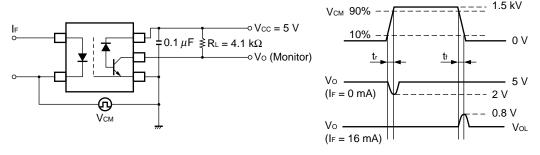
K: 20 to 35 (%) N: 15 to 35 (%)

*2 Test circuit for propagation delay time



C_L is approximately 15 pF which includes probe and stray wiring capacitance

*3 Test circuit for common mode transient immunity

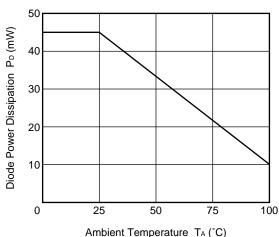


USAGE CAUTIONS

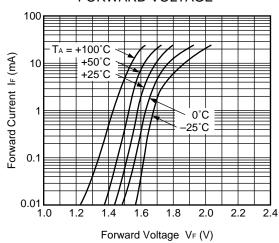
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

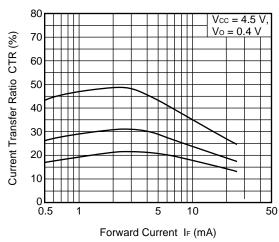




FORWARD CURRENT vs. FORWARD VOLTAGE

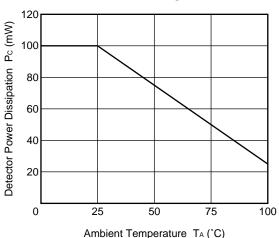


CURRENT TRANSFER RATIO vs. FORWARD CURRENT

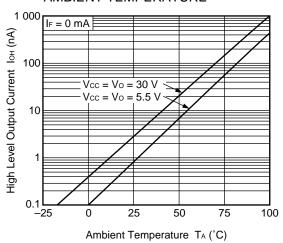


Remark The graphs indicate nominal characteristics.

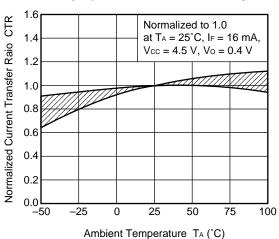
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE

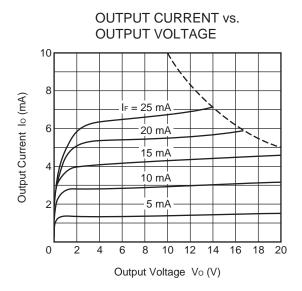


HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE

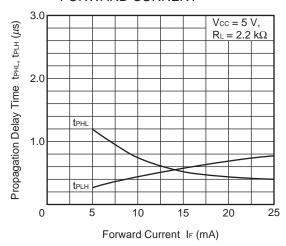


NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE

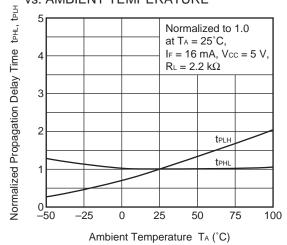




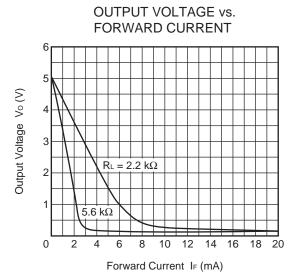
PROPAGATION DELAY TIME vs. FORWARD CURRENT



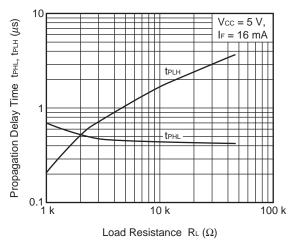
NORMALIZED PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



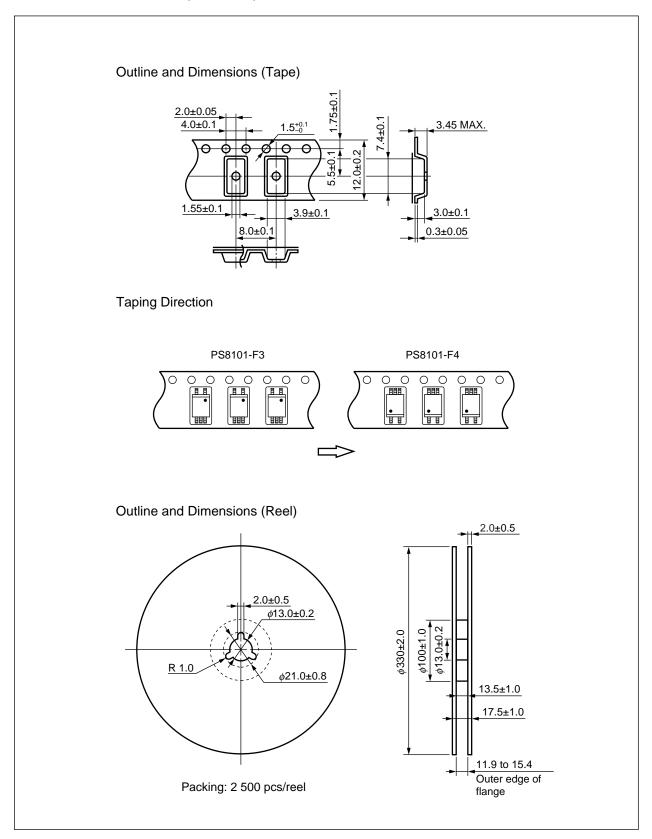
Remark The graphs indicate nominal characteristics.



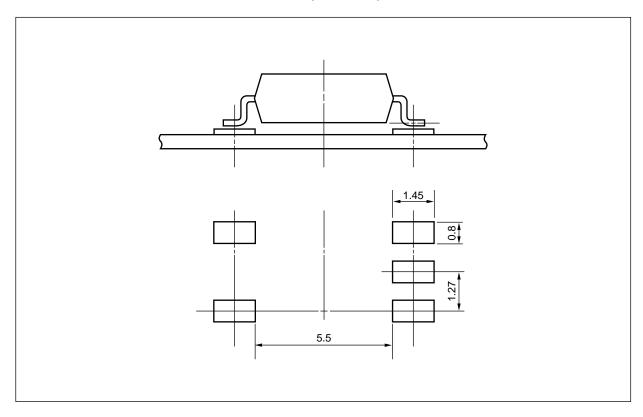
PROPAGATION DELAY TIME vs. LOAD RESISTANCE



TAPING SPECIFICATIONS (UNIT: mm)



<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

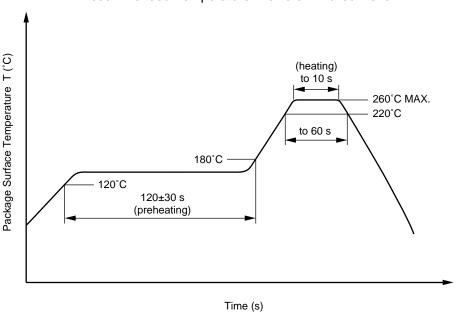
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s

Number of reflows
 Three

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN EN 60664-1 VDE0110)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 pC$	Uiorm Upr	707 1 061	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC$	U_pr	1 326	V _{peak}
Highest permissible overvoltage	Utr	6 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>4.2	mm
Creepage distance		>4.2	mm
Comparative tracking index (DIN IEC 112/VDE 0303 Part 1)	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value VIO = 500 V dc at TA = 25°C VIO = 500 V dc at TA MAX. at least 100°C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I _F , Psi = 0)	Tsi Isi	150 200	°C mA
Power (output or total power dissipation)	Psi	300	mW
Isolation resistance Vio = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

- The information in this document is current as of August, 2008. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC Electronics products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative
 purposes in semiconductor product operation and application examples. The incorporation of these
 circuits, software and information in the design of a customer's equipment shall be done under the full
 responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by
 customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".
 - The "Specific" quality grade applies only to NEC Electronics products developed based on a customer-designated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.
 - "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.